
2SB1387

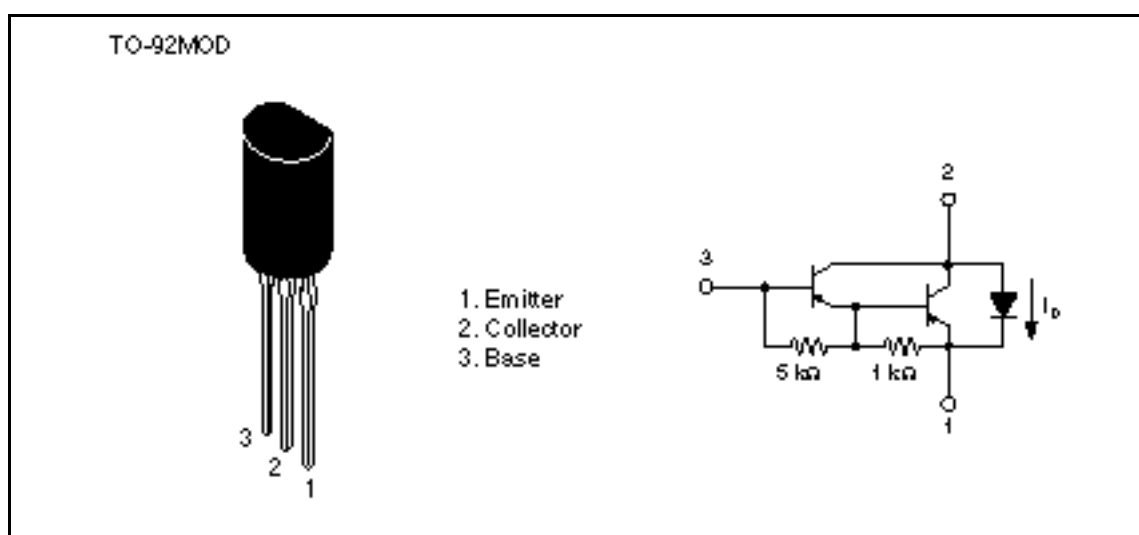
Silicon PNP Epitaxial, Darlington

HITACHI

Application

- Σ Low frequency power amplifier
- Σ Complementary pair with 2SD1978

Outline



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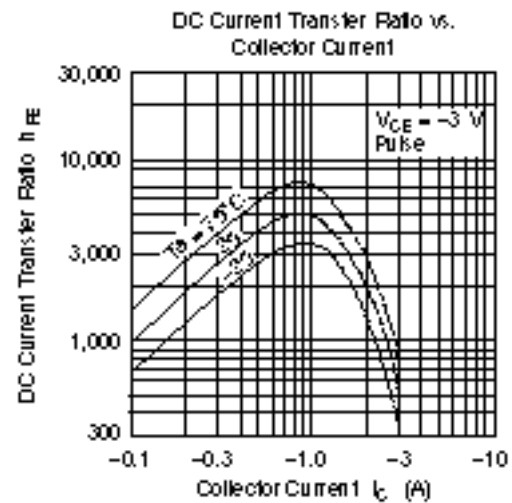
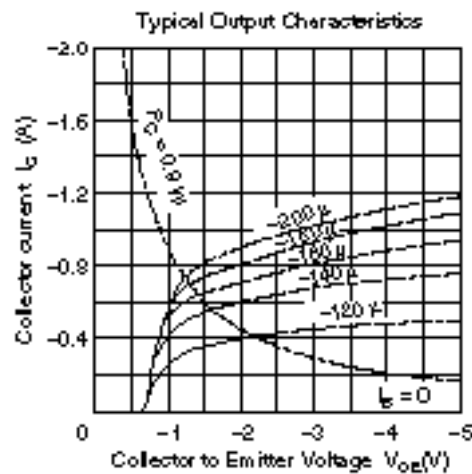
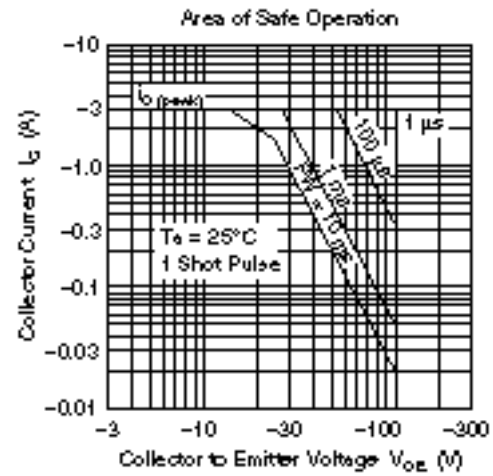
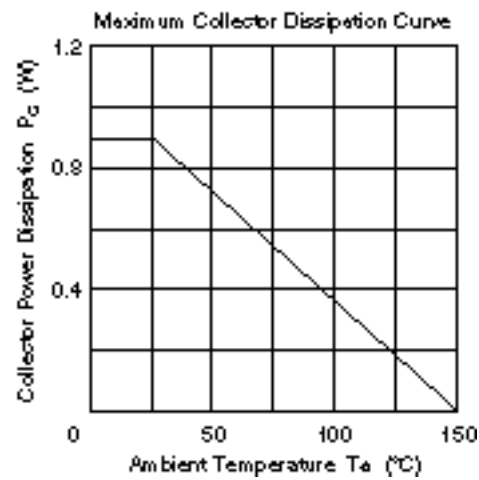
Absolute Maximum Ratings (Ta = 25°C)

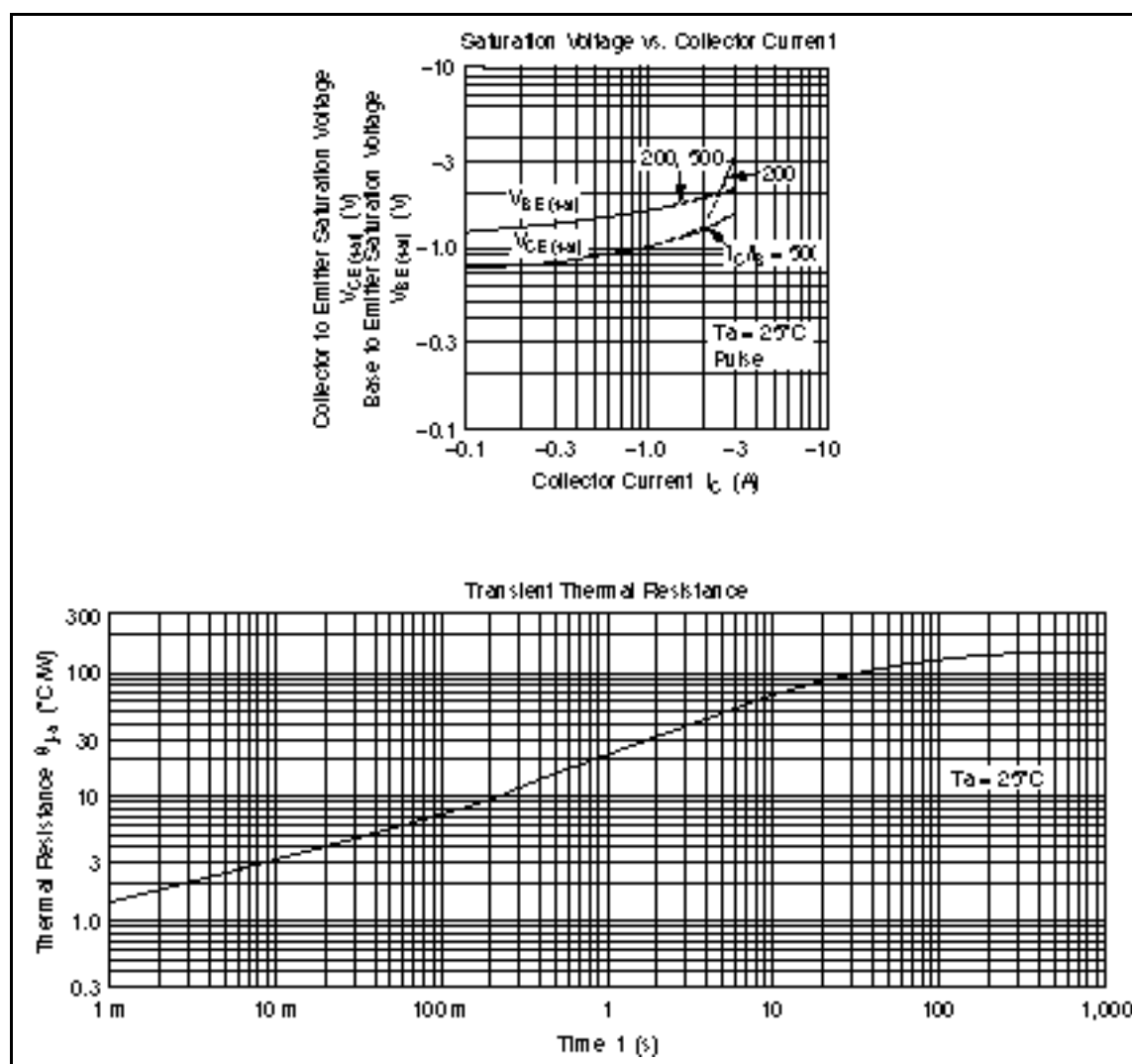
Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-120	V
Collector to emitter voltage	V_{CEO}	-120	V
Emitter to base voltage	V_{EBO}	-7	V
Collector current	I_C	-1.5	A
Collector peak current	$i_{C(peak)}$	-3.0	A
C to E diode forward current	I_D	1.5	A
Collector power dissipation	P_C	0.9	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-120	—	—	V	$I_C = -0.1 \text{ mA}$, $I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-120	—	—	V	$I_C = -10 \text{ mA}$, $R_{BE} = \bullet$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-7	—	—	V	$I_E = -50 \text{ mA}$, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	-1	μA	$V_{CB} = -100 \text{ V}$, $I_E = 0$
	I_{CEO}	—	—	-10	μA	$V_{CE} = -100 \text{ V}$, $R_{BE} = \bullet$
DC current transfer ratio	h_{FE}	2000	—	10000		$V_{CE} = -3 \text{ V}$, $I_C = -1 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)1}$	—	—	-1.5	V	$I_C = -1 \text{ A}$, $I_B = -1 \text{ mA}^{*1}$
	$V_{CE(sat)2}$	—	—	-2.0	V	$I_C = -1.5 \text{ A}$, $I_B = -1.5 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)1}$	—	—	-2.0	V	$I_C = -1 \text{ A}$, $I_B = -1 \text{ mA}^{*1}$
	$V_{BE(sat)2}$	—	—	-2.5	V	$I_C = -1.5 \text{ A}$, $I_B = -1.5 \text{ mA}^{*1}$
C to E diode forward voltage	V_D	—	—	3.0	V	$I_D = 1.5 \text{ A}^{*1}$

Note: 1. Pulse test





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